

Features:

- 1. Standard T-1 type package.
- 2. Hi-Eff Red and Yellow Green chips are matched for uniform light output.
- 3. Common Cathode.
- 4. Long life solid state reliability.
- 5. Low power consumption.
- 6. I.C. compatible.
- 7. The product itself will remain within RoHS complaint Version.

Descriptions:

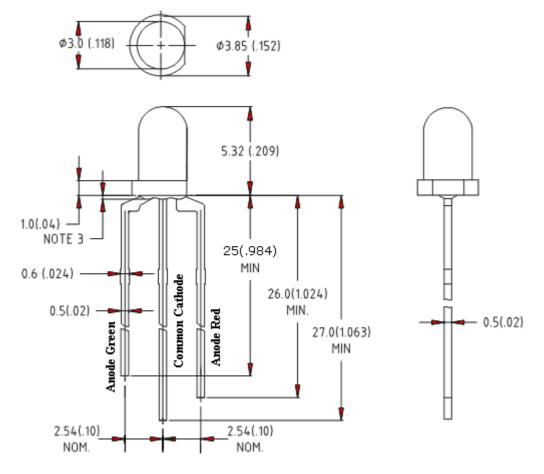
- 1. The lamp contain two integral chips and is available bicolor.
- 2. The Hi-Eff Red and Yellow Green light is emitted by diodes of GaAsP/GaP and GaP respectively.
- 3. White Diffused lens color.

Applications:

- 1. TV set.
- 2. Monitor.
- 3. Telephone.
- 4. Computer.
- 5. Circuit board.

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Package Dimension:



Part No.	Chip Material		Lens Color	Source Color
DL-309SRGMA-C	R	GaAsP	White Diffused	Hi-Eff Red
	G	GaP	white Diffused	Yellow Green

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25 mm (.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.00 mm (.039") max.
- 4. Specifications are subject to change without notice.

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▶ Absolute Maximum Ratings at Ta=25 ℃

Parameters		Symbol	Max.	Unit	
Power Dissipation	Hi-Eff Red	DD	78	mW	
	Yellow Green	PD	78		
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)		IFP	100	mA	
Super Red Chip Forward Current		IF	30	mA	
Yellow Green Chip Forward Current		IF	30	mA	
Reverse Voltage		VR	5	V	
Operating Temperature Range		Topr	-40℃ to +85℃		
Storage Temperature Range		Tstg	-40°C to +100°C		
Lead Soldering Temperature [4mm (.157") From Body]		Tsld	260°C for 5 Seconds		

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Electrical Optical Characteristics at Ta=25 ℃

Parameters	Symbol	Emitting Color	Min.	Тур.	Max.	Unit	Test Condition
	IV	Red	50	100		mcd	IF=20mA
Luminous Intensity		Green	30	55			
Viewing Angle	2θ _{1/2}	Red		60		Deg	
		Green		60			
Peak Emission Wavelength	λn	Red		630		nm	IE-20m Λ
	λр	Green		565		nm	IF=20mA
Dominant Wavelength	λd	Red		620		nm	IF=20mA
		Green		570			
Spectral Line Half-Width	Δλ	Red		42		nm	IF=20mA
		Green		30			
Forward Voltage	VF	Red	1.80	2.20	2.80	V	IF=20mA
		Green	1.80	2.20	2.80		
Reverse Current	IR	Red			10	μА	V _R =5V
		Green					

Notes:

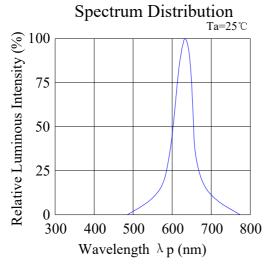
- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength (λ d) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

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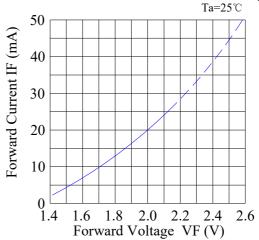
◆ Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

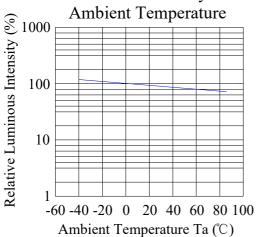
Red:



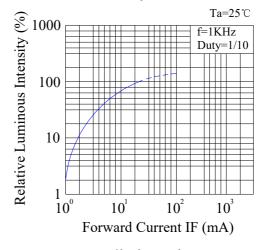
Forward Current & Forward Voltage



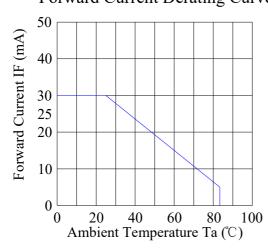
Luminous Intensity &



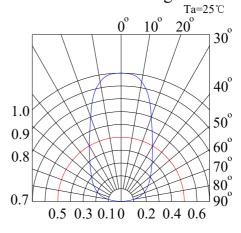
Luminous Intensity & Forward Current



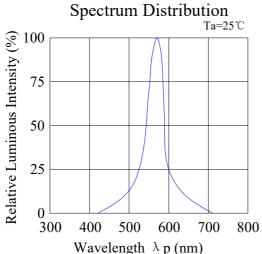
Forward Current Derating Curve

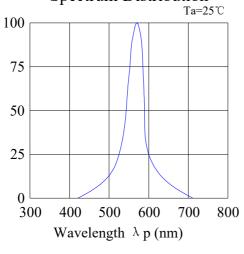


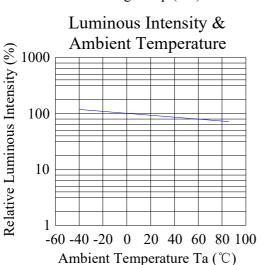
Radiation Diagram

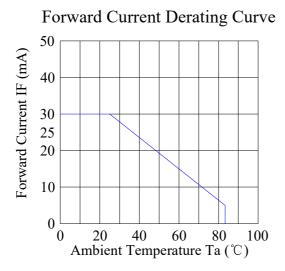


Green:

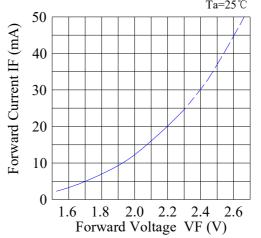




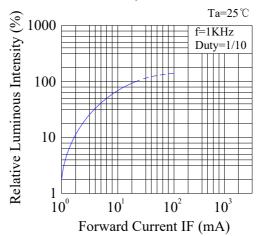




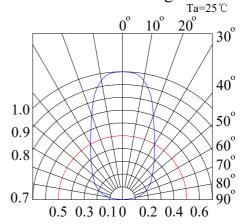




Luminous Intensity & Forward Current



Radiation Diagram



Reliability Test Items And Conditions:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%. LTPD: 10%.

1) Test Items and Results:

Test Item	Standard Test Method	Test Conditions	Note	Number of Damaged
Resistance to Soldering Heat	JEITA ED-4701 300 302	Tsld=260±5℃, 10sec 3mm from the base of the epoxy bulb	1 time	0/100
Solder ability	JEITA ED-4701 300 303	Tsld=235±5℃, 5sec (using flux)	1time over 95%	0/100
Thermal Shock	JEITA ED-4701 300 307	0°C~100°C 15sec, 15sec	100 cycles	0/100
Temperature Cycle	JEITA ED-4701 100 105	-40°C~25°C~100°C ~25°C 30min,5min,30min,5min	100 cycles	0/100
Moisture Resistance Cycle	JEITA ED-4701 200 203	25℃~65℃~-10℃ 90%RH 24hrs/1cycle	10 cycles	0/100
High Temperature Storage	JEITA ED-4701 200 201	Ta=100°C	1000hrs	0/100
Terminal Strength (Pull test)	JEITA ED-4701 400 401	Load 10N (1kgf) 10±1sec	No noticeable damage	0/100
Terminal Strength (bending test)	JEITA ED-4701 400 401	Load 5N (0.5kgf) 0°~90°~0° bend 2 times	No noticeable damage	0/100
Temperature Humidity Storage	JEITA ED-4701 100 103	Ta=60℃, RH=90%	1000hrs	0/100
Low Temperature Storage	JEITA ED-4701 200 202	Ta=-40°C	1000hrs	0/100
Steady State Operating Life		Ta=25℃, IF=20mA	1000hrs	0/100
Steady State Operating Life of High Humidity Heat		Ta=60℃, RH=90%, IF=20mA	500hrs	0/100
Steady State Operating Life of Low Temperature		Ta=-30℃, IF=30mA	1000hrs	0/100

2) Criteria for Judging the Damage:

ltem	Symbol	Test Conditions	Criteria for Judgment		
		lest Conditions	Min	Max	
Forward Voltage	VF	IF=20mA		F.V.*)×1.1	
Reverse Current	IR	VR=5V		F.V.*)×2.0	
Luminous Intensity	IV	IF=20mA	F.V.*)×0.7		

*) F.V.: First Value.

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Please read the following notes before using the product:

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 90%RH or less.
 - 2.3 The LEDs should be used within a year.
 - 2.4 After opening the package, the LEDs should be kept at 30℃ or less and 70%RH or less.
 - 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 3. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260° C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

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